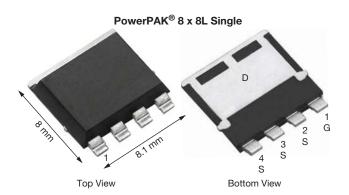
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Vishay Siliconix

Automotive N-Channel 40 V (D-S) 175 °C MOSFET



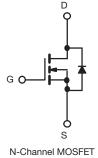
PRODUCT SUMMARY	
V _{DS} (V)	40
$R_{DS(on)}$ (Ω) at V_{GS} = 10 V	0.0012
$R_{DS(on)}$ (Ω) at V_{GS} = 4.5 V	0.0015
I _D (A)	200
Configuration	Single
Package	PowerPAK 8 x 8L

FEATURES

- TrenchFET[®] power MOSFET
- AEC-Q101 qualified
- 100 % R_q and UIS tested
- Fully lead (Pb)-free device
- Thin 1.9 mm height
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



FREE



PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	40	V	
Gate-source voltage	V _{GS}	± 20	V		
Continuous drain current	T _C = 25 °C ª	I	200	A	
	T _C = 125 °C	Ι _D	141		
Continuous source current (diode conduct	ion)	I _S	136		
Pulsed drain current ^b	I _{DM}	600			
Single pulse avalanche current	L = 0.1 mH	I _{AS}	50		
Single pulse avalanche energy	L = 0.1 MH	E _{AS}	125	mJ	
Maximum power dissipation	T _C = 25 °C		150	14/	
	T _C = 125 °C	P _D	50	W	
Operating junction and storage temperatu	T _J , T _{stg}	-55 to +175	*0		
Soldering recommendations (peak temper	Ŭ	260	°C		

THERMAL RESISTANCE RATINGS PARAMETER SYMBOL LIMIT UNIT PCB mount ^c Junction-to-ambient R_{thJA} 50 °C/W Junction-to-case (drain) 1 R_{thJC}

Notes

a. Package limited

b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

c. When mounted on 1" square PCB (FR4 material)

d. See solder profile (www.vishay.com/doc?73257). The PowerPAK 8 x 8L is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection

e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components

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PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static		•			•			
Drain-source breakdown voltage	V _{DS}	V _{GS}	= 0, I _D = 250 μA	40	-	-	v	
Gate-source threshold voltage	V _{GS(th)}	$V_{DS}=V_{GS},\ I_{D}=250\ \mu A$		1.5	2	2.5	V	
Gate-source leakage	I _{GSS}	V _{DS} =	0 V, V _{GS} = ± 20 V	-	-	± 100	nA	
		$V_{GS} = 0 V$	V _{DS} = 40 V	-	-	1		
Zero gate voltage drain current	I _{DSS}	$V_{GS} = 0 V$	$V_{DS} = 40 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$	-	-	50	μA	
		$V_{GS} = 0 V$	V _{DS} = 40 V, T _J = 175 °C	-	-	500	1	
On-state drain current ^a	I _{D(on)}	$V_{GS} = 10 V$	$V_{DS} \ge 5 V$	100	-	-	Α	
		$V_{GS} = 10 \text{ V}$	I _D = 20 A	-	0.0009	0.0012		
Drain-source on-state resistance ^a Forward transconductance ^b Dynamic ^b	P	V _{GS} = 4.5 V	I _D = 10 A	-	0.0011	0.0015	Ω	
	R _{DS(on)}	$V_{GS} = 10 V$	I _D = 20 A, T _J = 125 °C	-	-	0.0018		
		$V_{GS} = 10 \text{ V}$	I _D = 20 A, T _J = 175 °C	-	-	0.0022		
Forward transconductance ^b	9 _{fs}	$V_{DS} = 15 \text{ V}, I_D = 15 \text{ A}$		-	122	-	S	
Dynamic ^b		•						
Input capacitance	C _{iss}			-	10 810	14 500		
Output capacitance	C _{oss}	$V_{GS} = 0 V$	V _{DS} = 25 V, f = 1 MHz	-	6500	8500	pF	
Reverse transfer capacitance	C _{rss}			-	700	950		
Total gate charge ^c	Qg			-	140	220		
Gate-source charge ^c	Q _{gs}	$V_{GS} = 10 V$	$V_{DS} = 20 \text{ V}, \text{ I}_{D} = 10 \text{ A}$	-	30	-	nC	
Gate-drain charge ^c	Q _{gd}			-	20	-		
Gate resistance	Rg		f = 1 MHz	0.45	0.99	1.50	Ω	
Turn-on delay time ^c	t _{d(on)}			-	24	40		
Rise time ^c	t _r	V_{DD} = 20 V, R_L = 2 Ω		-	60	100		
Turn-off delay time ^c	t _{d(off)}	$I_D \cong 10 \text{ A},$	V_{GEN} = 10 V, R_g = 1 Ω	-	60	100	ns	
Fall time ^c	t _f			-	30	50		
Source-Drain Diode Ratings and Cha	aracteristics ^b				-	-		
Pulsed current ^a	I _{SM}			-	-	200	Α	
Forward voltage	V _{SD}	I _F = 50 A, V _{GS} = 0		-	0.8	1.2	V	

Notes

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing

c. Independent of operating temperature

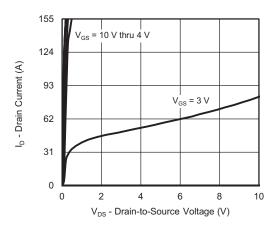
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

2

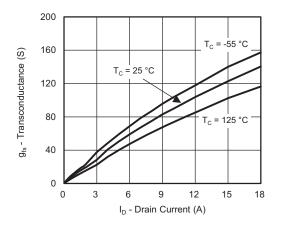


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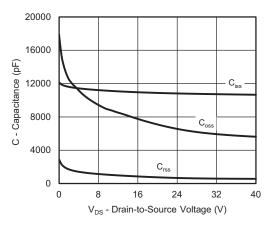
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



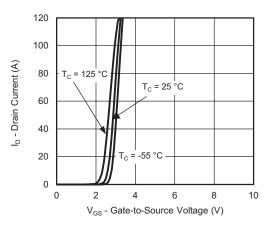
Output Characteristics



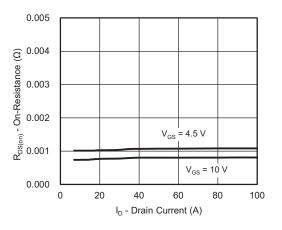
Transconductance



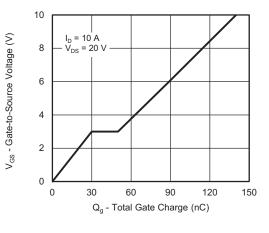
Capacitance



Transfer Characteristics



On-Resistance vs. Drain Current



Gate Charge

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3

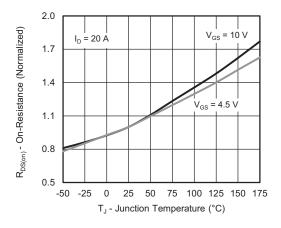
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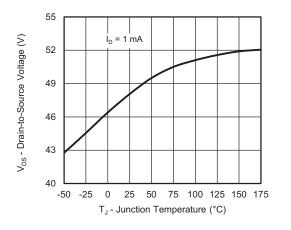


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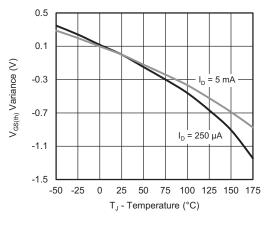
TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)



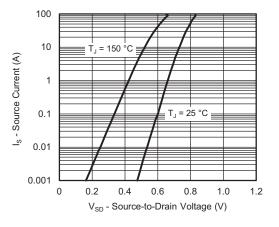
On-Resistance vs. Junction Temperature



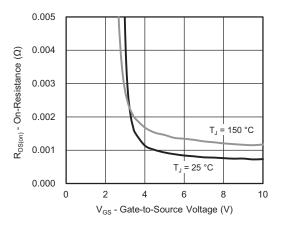
Drain Source Breakdown vs. Junction Temperature



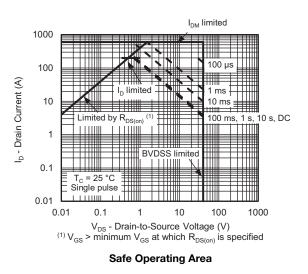
Threshold Voltage



Source Drain Diode Forward Voltage



On-Resistance vs. Gate-to-Source Voltage



4

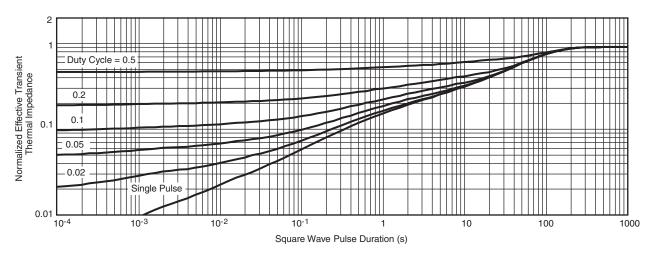
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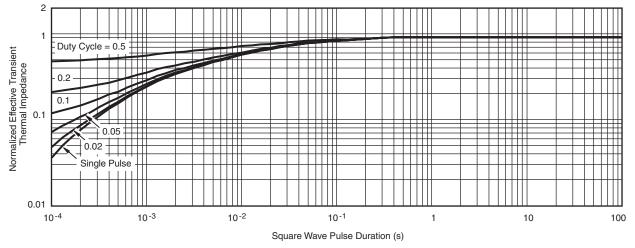


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THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient

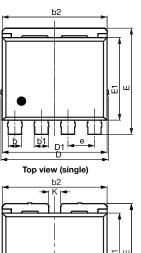


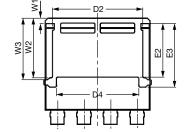
Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?68443.

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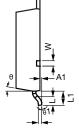
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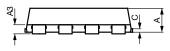


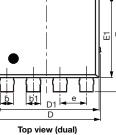
PowerPAK[®] 8 x 8L Case Outline

Bottom view (single)



0.25 gauge line





≦. D3 🗕 _D3 W3 W2 Ш

Bottom view (dual)

DIM	MILLIMETERS			INCHES			
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
А	1.70	1.80	1.90	0.067	0.071	0.075	
A1	0.00	0.08	0.13	0.000	0.003	0.005	
A3	0.55	0.62	0.70	0.022	0.024	0.028	
b	0.92	1.00	1.08	0.036	0.039	0.043	
b1	1.02	1.10	1.18	0.040	0.043	0.046	
b2	7.80	7.90	8.00	0.307	0.311	0.315	
С	0.20	0.25	0.30	0.008	0.010	0.012	
D	8.00	8.10	8.25	0.315	0.319	0.325	
D1	7.80	7.90	8.00	0.307	0.311	0.315	
D2	6.70	6.80	6.90	0.264	0.268	0.272	
D3	2.85	2.95	3.05	0.112	0.116	0.120	
D4	6.11	6.21	6.31	0.241	0.244	0.248	
е	1.95	2.00	2.05	0.077	0.079	0.081	
E	7.90	8.00	8.10	0.311	0.315	0.319	
E1	6.12	6.22	6.32	0.241	0.245	0.249	
E2	3.94	4.04	4.14	0.140	0.159	0.163	
E3	4.69	4.79	4.89	0.185	0.189	0.193	
F	0.05	0.10	0.15	0.002	0.004	0.006	
L	0.62	0.72	0.82	0.024	0.028	0.032	
L1	0.92	1.07	1.22	0.036	0.042	0.048	
K	0.80	0.90	1.00	0.031	0.035	0.039	
W	0.30	0.40	0.50	0.012	0.016	0.020	
W1	0.30	0.40	0.50	0.012	0.016	0.020	
W2	4.39	4.49	4.59	0.173	0.177	0.181	
W3	4.54	4.64	4.74	0.179	0.183	0.187	
θ	6°	10°	14°	6°	10°	14°	
θ1	0°	3°	8°	0°	3°	8°	

Revision: 06-Oct-14

For technical questions, contact: pmostechsupport@vishay.com

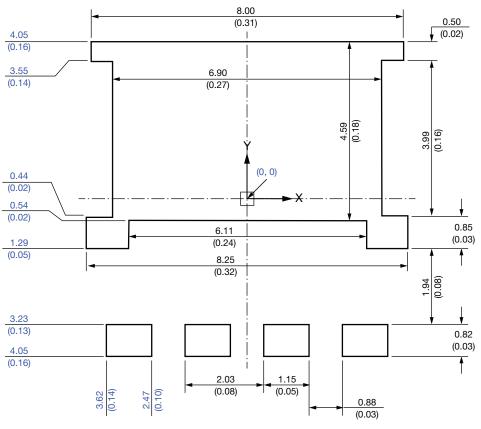
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1



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Recommended Minimum PADs for PowerPAK® 8 x 8L Single



Dimensions in millimeters (inches)

Note

• Linear dimensions are in black, the same information is provided in ordinate dimensions which are in blue.



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